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**NATIONAL STANDARD OF THE  
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**Test methods for solders**

软钎料试验方法

**(English Translation)**

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### What this standard covers

This standard specifies the tensile test solder wettability test, QFP lead soldered joints 45° angle pull-off test (see Appendix B) and chip components solder joint shear test method (see Appendix C). This standard applies to lead-free solder and tin-lead solder.

### Document data

International classification (ICS): 25.160.50.

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### Standards quoted by this document

GB/T 228.1-2010; GB/T 622-2006; GB/T 686-2008; GB/T 2040-2008; GB/T 3375; GB/T 7814-2008; GB/T 8170-2008; GB/T 14020-2006; GB/T 16261-1996; GB/T 19405.1-2003; GB/T 21652-2008; SJ/T 10668-2002